MOSFET – Power, N-Channel, SUPERFET III, Easy Drive

650 V, 19 A, 165 m Ω

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate. Consequently, SUPERFET III MOSFET Easy drive series helps manage EMI issues and allows for easier design implementation.

Features

- 700 V @ T_J = 150°C
- Typ. $R_{DS(on)} = 140 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. $Q_g = 39 \text{ nC}$)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 341 pF)
- 100% Avalanche Tested

Applications

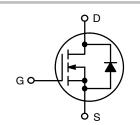
- Telecom / Server Power Supplies
- Industrial Power Supplies
- UPS / Solar



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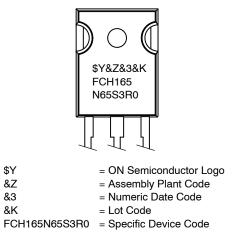
V _{DSS}	R _{DS(ON)} MAX	I _D MAX
650 V	165 m Ω @ 10 V	19 A



N-Channel MOSFET



MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Paramo	eter	Value	Unit			
V _{DSS}	Drain to Source Voltage		650	V			
V _{GSS}	Gate to Source Voltage	DC	±30	V			
		AC (f > 1 Hz)	±30	V			
I _D	Drain Current	Continuous (T _C = 25°C)	19	А			
		Continuous (T _C = 100°C)	12.3				
I _{DM}	Drain Current Pulsed (Note 1) 47.5	Pulsed (Note 1) 47.5	nt Pulsed (Note 1) 47.5	Drain Current Pulsed (Note 1) 47.5	Prain Current Pulsed (Note 1) 47.5	47.5	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		87	mJ			
I _{AS}	Avalanche Current (Note 2)		2.7	А			
E _{AR}	Repetitive Avalanche Energy (Note 1)		1.54	mJ			
dv/dt	MOSFET dv/dt		100	V/ns			
	Peak Diode Recovery dv/dt (Note 3)		20				
PD	Power Dissipation	(T _C = 25°C)	154	W			
		Derate Above 25°C	1.23	W/°C			
T _J , T _{STG}	Operating and Storage Temperature Rar	nge	-55 to +150	°C			
ΤL	Maximum Lead Temperature for Solderin	ng, 1/8" from Case for 5 s	300	°C			

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 2.7 \text{ A}, R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \le 9.5 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, \text{V}_{DD} \le 400 \text{ V}, \text{ starting } T_J = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.81	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Shipping
FCH165N65S3R0-F155	FCH165N65S3R0	TO-247-3LD	30 Units / Tube

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit			
OFF CHARACTERISTICS									
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	650			V			
		V_{GS} = 0 V, I _D = 1 mA, T _J = 150°C	700			V			
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to $25^{\circ}C$		0.64		V/°C			
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 650 V, V_{GS} = 0 V			1	μA			
		V_{DS} = 520 V, T_{C} = 125 °C		0.85					
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 30$ V, $V_{DS} = 0$ V			±100	nA			
ON CHARACTE	RISTICS	1		1	1	<u>I</u>			

V _G	àS(th)	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 0.44 \text{ mA}$	2.5		4.5	V
R _D	S(on)	Static Drain to Source On Resistance	V_{GS} = 10 V, I _D = 9.5 A		140	165	mΩ
g	FS	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 9.5 \text{ A}$		12		S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 400 V, V_{GS} = 0 V, f = 1 MHz	1500	pF
C _{oss}	Output Capacitance		35	pF
C _{oss(eff.)}	Effective Output Capacitance	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$	341	pF
C _{oss(er.)}	Energy Related Output Capacitance	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$	49	pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 400 \text{ V}, \text{ I}_{D} = 9.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	39	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	11	nC
Q _{gd}	Gate to Drain "Miller" Charge]	16	nC
ESR	Equivalent Series Resistance	f = 1 MHz	0.5	Ω

SWITCHING CHARACTERISTICS

t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 9.5 \text{ A},$	17	ns
tr	Turn-On Rise Time	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$ (Note 4)	15	ns
t _{d(off)}	Turn-Off Delay Time		44	ns
t _f	Turn-Off Fall Time		5	ns

SOURCE-DRAIN DIODE CHARACTERISTICS

۱ _S	Maximum Continuous Source to Drain Diode Forward Current			19	А
I _{SM}	Maximum Pulsed Source to Drain Diode Forward Current			47.5	А
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 9.5 A		1.2	V
t _{rr}	Reverse Recovery Time	$V_{DD} = 400 \text{ V}, \text{ I}_{SD} = 9.5 \text{ A},$	339		ns
Q _{rr}	Reverse Recovery Charge	$- dI_F/dt = 100 \text{ A}/\mu \text{s}$	5.8		μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

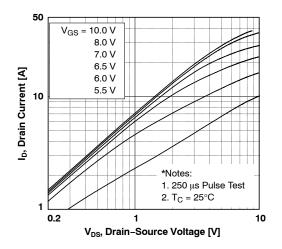


Figure 1. On-Region Characteristics

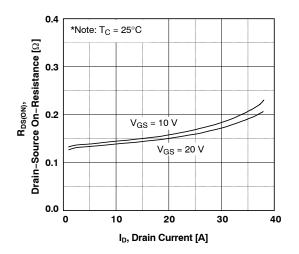


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

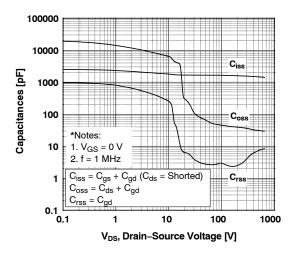


Figure 5. Capacitance Characteristics

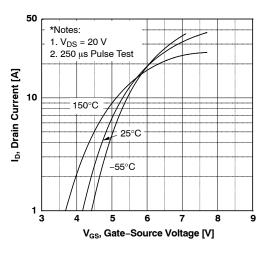


Figure 2. Transfer Characteristics

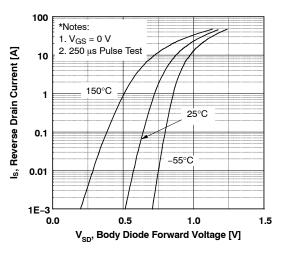


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

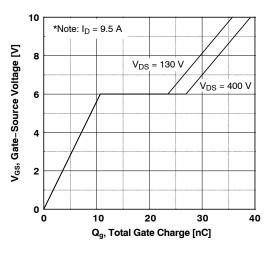
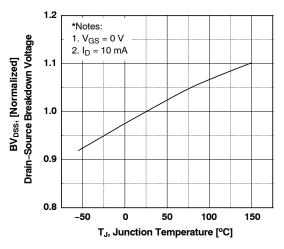
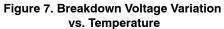


Figure 6. Gate Charge Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





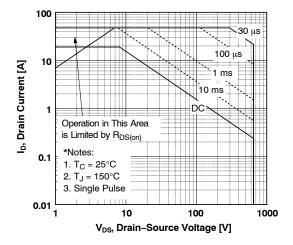


Figure 9. Maximum Safe Operation Area

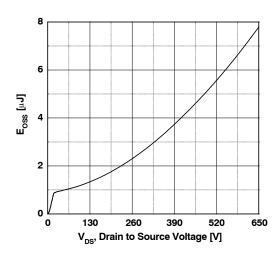


Figure 11. E_{OSS} vs. Drain to Source Voltage

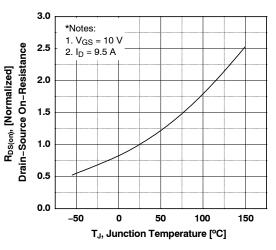


Figure 8. On-Resistance Variant vs. Temperature

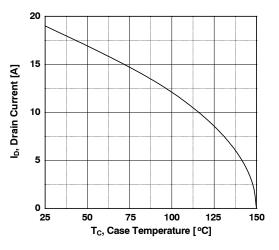


Figure 10. Maximum Drain Current vs. Case Temperature

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

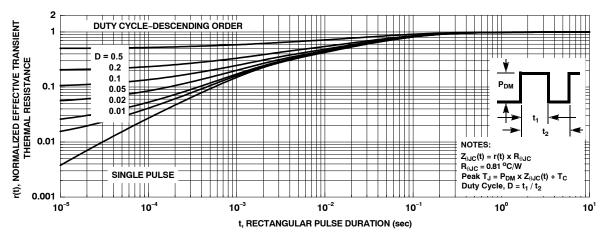
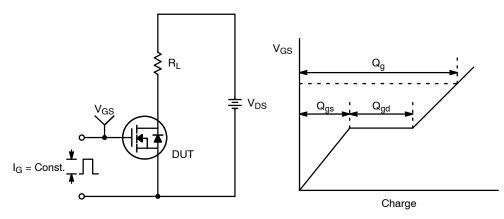


Figure 12. Transient Thermal Response Curve





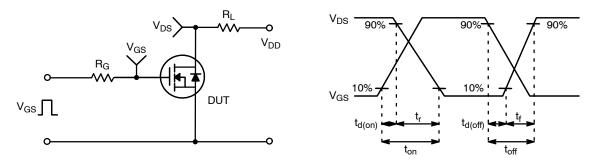


Figure 14. Resistive Switching Test Circuit & Waveforms

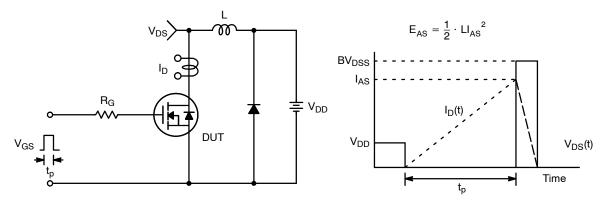


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

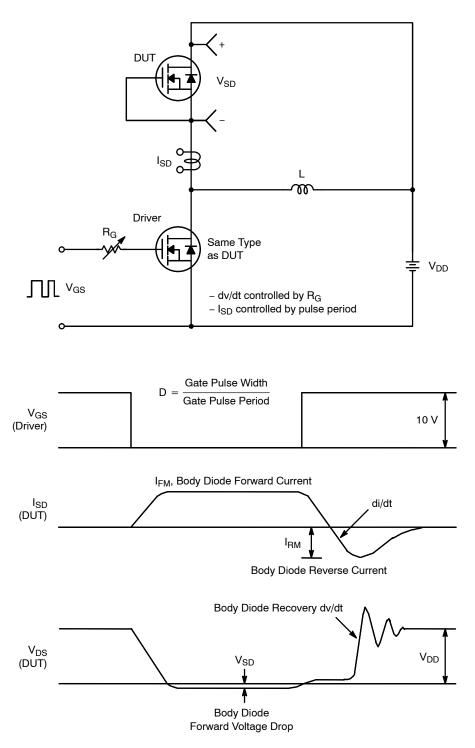
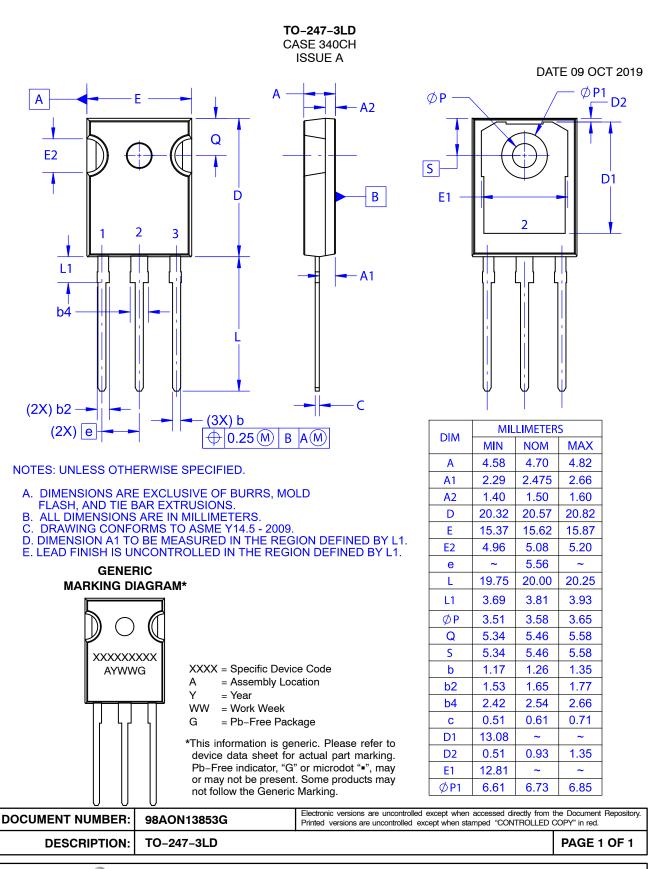


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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